

Features

- Operating range from $V_{CC} = 2.7V$ to 6V
- Rail-to-rail input and output
- Extended V_{icm} ($V_{DD} - 0.2V$ to $V_{CC} + 0.2V$)
- Low supply current (145 μA)
- Gain bandwidth product (1MHz)
- ESD tolerance (2kV)
- Latch-up immunity
- Available in SOT23-5 micropackage

Applications

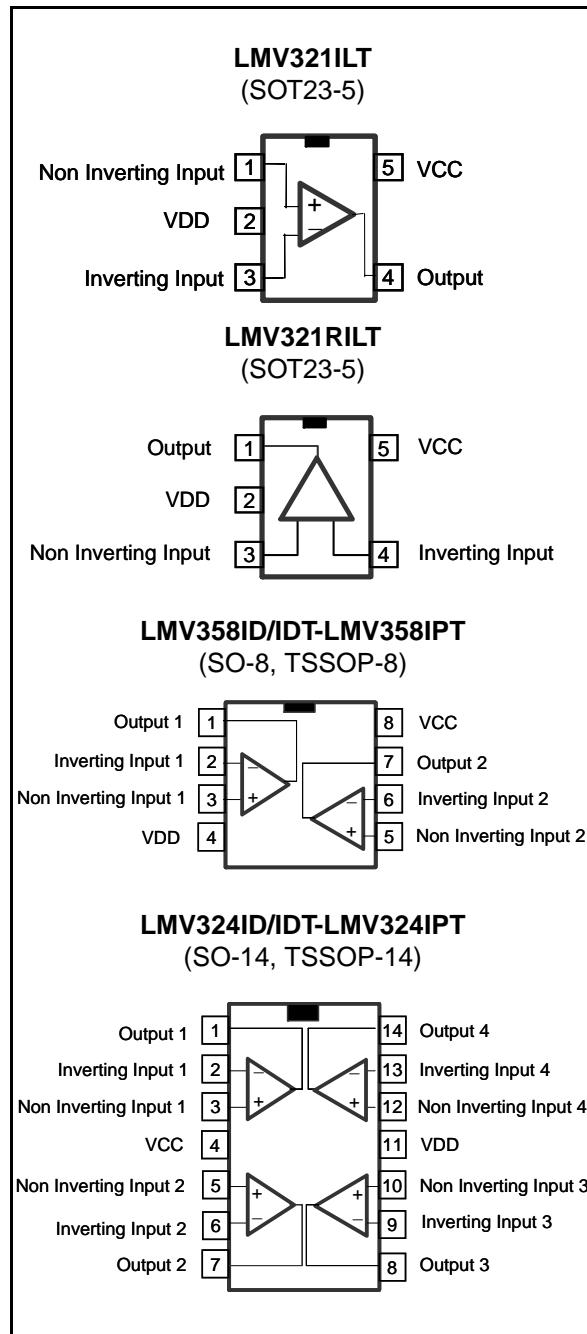
- Two-cell battery-powered systems
- Battery-powered electronic equipment
- Cordless phones
- Personal medical care (glucose meter)
- Laptops
- PDAs

Description

The LMV321/358/324 family (single, dual and quad) answer the need for low cost, general purpose operational amplifiers. It operates with voltages as low as 2.7V and features both input and output rail-to-rail, 145 μA consumption current and 1MHz gain bandwidth product (GBP).

With a such low consumption and a sufficient GBP for many applications, these op-amps are very well-suited for any kind of battery-supplied and portable equipment application.

The LMV321 is housed in the space-saving 5-pin SOT23-5 package which simplifies the board design (outside dimensions are 2.8mm x 2.9mm). The SOT23-5 has two pinning configurations to answer all application requirements.



1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	7	V
V_{id}	Differential input voltage ⁽²⁾	± 1	V
V_i	Input voltage	$V_{DD}-0.3$ to $V_{CC}+0.3$	V
T_{oper}	Operating free air temperature range	-40 to + 125	°C
T_{stg}	Storage temperature	-65 to +150	°C
T_j	Maximum junction temperature	150	°C
R_{thja}	Thermal resistance junction to ambient ⁽³⁾ SOT23-5 SO-8 SO-14 TSSOP8 TSSOP14	250 125 103 120 100	°C/W
R_{thjc}	Thermal resistance junction to case SOT23-5 SO-8 SO-14 TSSOP8 TSSOP14	81 40 31 37 32	°C/W
ESD	HBM: human body model ⁽⁴⁾	2	kV
	MM: machine model ⁽⁵⁾	200	V
	CDM: charged device model ⁽⁶⁾	1.5	kV
	Lead temperature (soldering, 10sec)	250	°C
	Output short-circuit duration	see note ⁽⁷⁾	

1. All voltage values, except differential voltage are with respect to network terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal. If $V_{id} > \pm 1V$, the maximum input current must not exceed $\pm 1mA$. In this case ($V_{id} > \pm 1V$), an input series resistor must be added to limit input current.
3. Short-circuits can cause excessive heating. Destructive dissipation can result from simultaneous short-circuits on all amplifiers. All values are typical.
4. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a $1.5k\Omega$ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
5. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor $< 5\Omega$). This is done for all couples of connected pin combinations while the other pins are floating.
6. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.
No value specified for CDM on SOT23-5L package. The value is given for SO and TSSOP packages.
7. Short-circuits from the output to V_{CC} can cause excessive heating. The maximum output current is approximately 48mA, independent of the magnitude of V_{CC} . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.7 to 6	V
V_{icm}	Common mode input voltage range ⁽¹⁾	$V_{DD} -0.2$ to $V_{CC} + 0.2$	V
V_{icm}	Common mode input voltage range ⁽²⁾	V_{DD} to V_{CC}	V
T_{oper}	Operating free air temperature range	-40 to + 125	°C

1. At 25°C, for $2.7 \leq V_{CC} \leq 6$ V, V_{icm} is extended to $V_{DD} - 0.2$ V, $V_{CC} + 0.2$ V.

2. In full temperature range, both rails can be reached when V_{CC} does not exceed 5.5V.

2 Electrical characteristics

Table 3. $V_{CC} = +2.7V$, $V_{DD} = 0V$, C_L & R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		0.1 6	3	mV
ΔV_{io}	Input offset voltage drift			2		$\mu V/^\circ C$
I_{io}	Input offset current	$V_{icm} = V_{out} = V_{CC}/2$ ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		1 25	9	nA
I_{ib}	Input bias current	$V_{icm} = V_{out} = V_{CC}/2$ ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		10 85	50	nA
CMR	Common mode rejection ratio	$0 \leq V_{icm} \leq V_{CC}$	55	85		dB
SVR	Supply voltage rejection ratio	$V_{icm} = V_{CC}/2$	70	80		dB
A_{vd}	Large signal voltage gain	$V_{out} = 0.5V$ to $2.2V$ $R_L = 10k\Omega$ $R_L = 2k\Omega$	80 70	100 88		dB
V_{OH}	High level output voltage	$V_{id} = 100mV$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$	2.6 2.55	2.65 2.6		V
V_{OL}	Low level output voltage	$V_{id} = -100mV$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$		15 50	90 100	mV
I_o	Output current	Output source current $V_{id} = 100mV$, $V_O = V_{DD}$ Output sink current $V_{id} = -100mV$, $V_O = V_{CC}$	5 5	46 46		mA
I_{CC}	Supply current (per amplifier)	$V_{out} = V_{CC}/2$ $A_{VCL} = 1$, no load $T_{min} \leq T_{amb} \leq T_{max}$		145 230	200	μA
GBP	Gain bandwidth product	$R_L = 10k\Omega$, $C_L = 100pF$, $f = 100kHz$		1		MHz
SR	Slew rate	$R_L = 600\Omega$, $C_L = 100pF$, $A_V = 1$		0.35		V/ μs
ϕ_m	Phase margin	$R_L = 600\Omega$, $C_L = 100pF$		44		Degrees
en	Input voltage noise			40		nV/ \sqrt{Hz}
THD	Total harmonic distortion			0.01		%

1. Maximum values include unavoidable inaccuracies of the industrial tests.

Table 4. $V_{CC} = +5V$, $V_{DD} = 0V$, C_L & R_L connected to $V_{CC}/2$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		0.1 6	3 6	mV
ΔV_{io}	Input offset voltage drift			2		$\mu V/^\circ C$
I_{io}	Input offset current	$V_{icm} = V_{out} = V_{CC}/2$ ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		1 25	9 25	nA
I_{ib}	Input bias current	$V_{icm} = V_{out} = V_{CC}/2$ ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		16 95	63 95	nA
CMR	Common mode rejection ratio	$0 \leq V_{icm} \leq V_{CC}$	65	95		dB
SVR	Supply voltage rejection ratio	$V_{icm} = V_{CC}/2$	70	90		dB
A_{vd}	Large signal voltage gain	$V_{out} = 0.5V$ to $4.5V$ $R_L = 10k\Omega$ $R_L = 2k\Omega$	85 77	97 93		dB
V_{OH}	High level output voltage	$V_{id} = 100mV$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$	4.85 4.8	4.95 4.91		V
V_{OL}	Low level output voltage	$V_{id} = -100mV$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$		40 80	180 200	mV
I_o	Output current	Output source current $V_{id} = 100mV$, $V_O = V_{DD}$ Output sink current $V_{id} = -100mV$, $V_O = V_{CC}$	7 7	48 48		mA
I_{CC}	Supply current (per amplifier)	$V_{out} = V_{CC}/2$ $A_{VCL} = 1$, no load $T_{min} \leq T_{amb} \leq T_{max}$		162	220 250	μA
GBP	Gain bandwidth product	$R_L = 10k\Omega$, $C_L = 100pF$, $f = 100kHz$		1.3		MHz
SR	Slew rate	$R_L = 600\Omega$, $C_L = 100pF$, $A_V = 1$		0.45		V/ μs
ϕ_m	Phase margin	$R_L = 600\Omega$, $C_L = 100pF$		48		Degrees
en	Input voltage noise			40		nV/ \sqrt{Hz}
THD	Total harmonic distortion			0.01		%

1. Maximum values include unavoidable inaccuracies of the industrial tests.

Figure 1. Supply current/amplifier vs. supply voltage

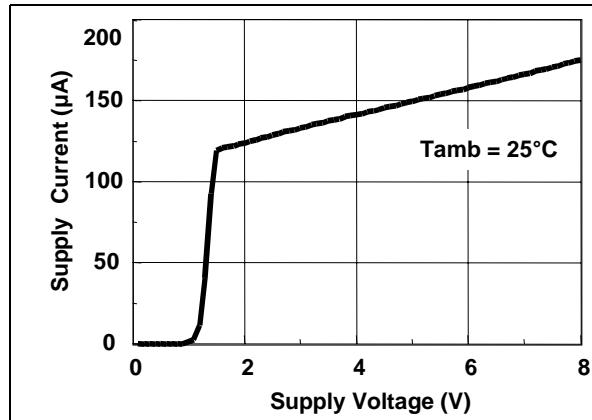


Figure 2. Input bias current vs. temperature

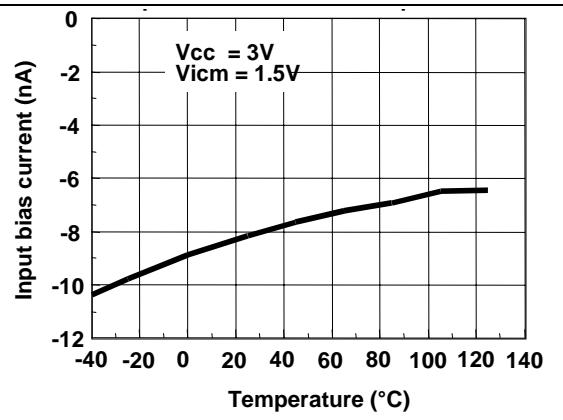


Figure 3. Input bias current vs. temperature

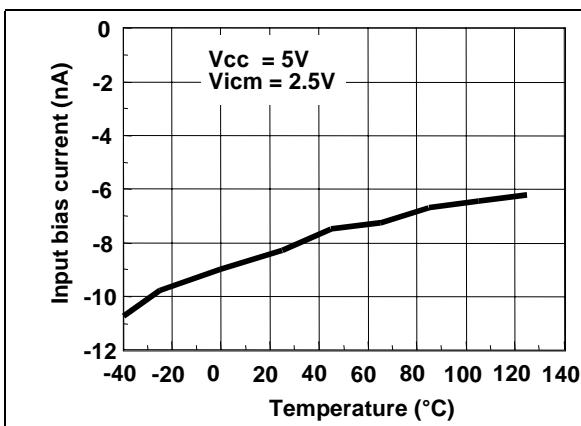


Figure 4. Common mode rejection vs. temperature

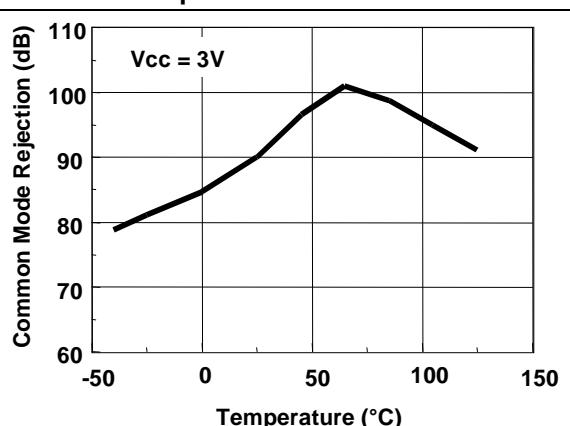


Figure 5. Common mode rejection vs. temperature

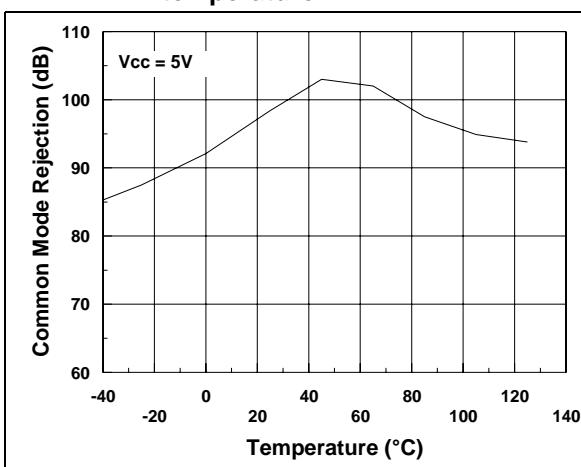


Figure 6. Supply voltage rejection vs. temperature

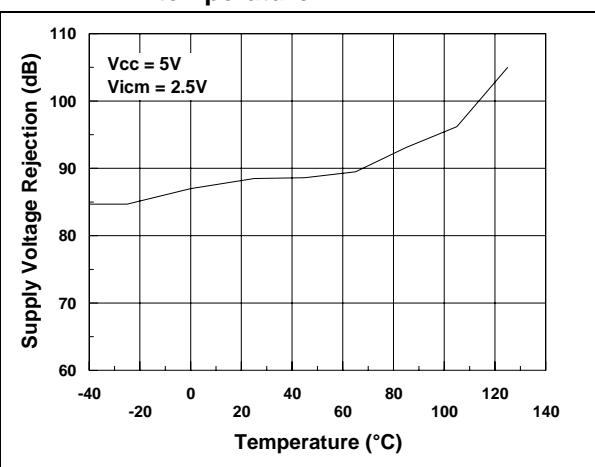
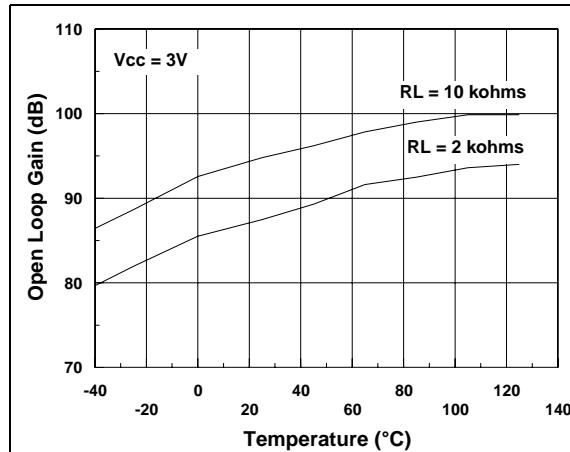
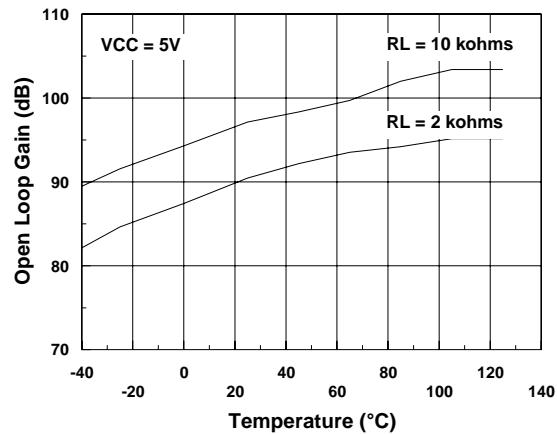
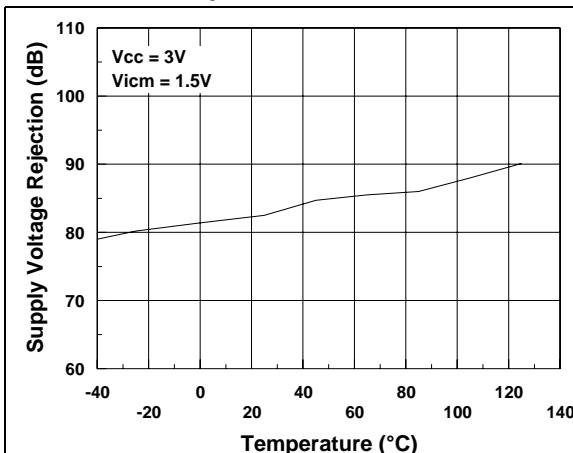
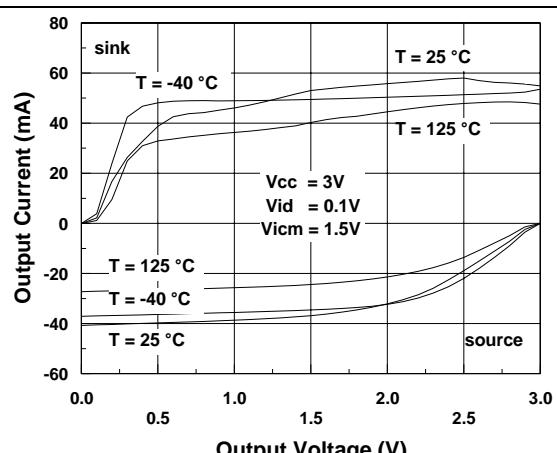
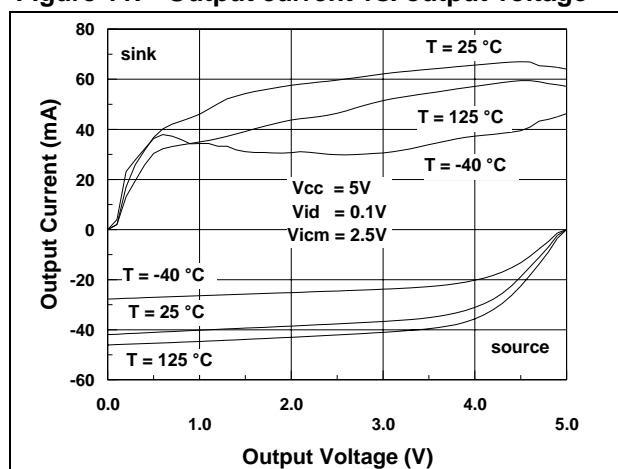


Figure 7. Open loop gain vs. temperature**Figure 8.** Open loop gain vs. temperature**Figure 9.** Supply voltage rejection vs. temperature**Figure 10.** Output current vs. output voltage**Figure 11.** Output current vs. output voltage

3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

3.1 SO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

The figure contains four detailed mechanical drawings of the SO-8 package:

- Top View:** Shows the package from above with pins numbered 1 through 8. Dimensions include height E1, width m, and lead spacing e.
- Side View:** Shows the package in perspective with lead thickness A, lead spacing b, and lead height A2.
- Cross-Section:** Shows the cross-section of the lead with lead angle k, lead height h, and lead thickness A. It also shows the seating plane (C) and gage plane (0.25 mm).
- Bottom View:** Shows the package from below with pins numbered 1 through 8. Dimensions include height E1, width m, and lead spacing e.

3.2 TSSOP8 package mechanical data

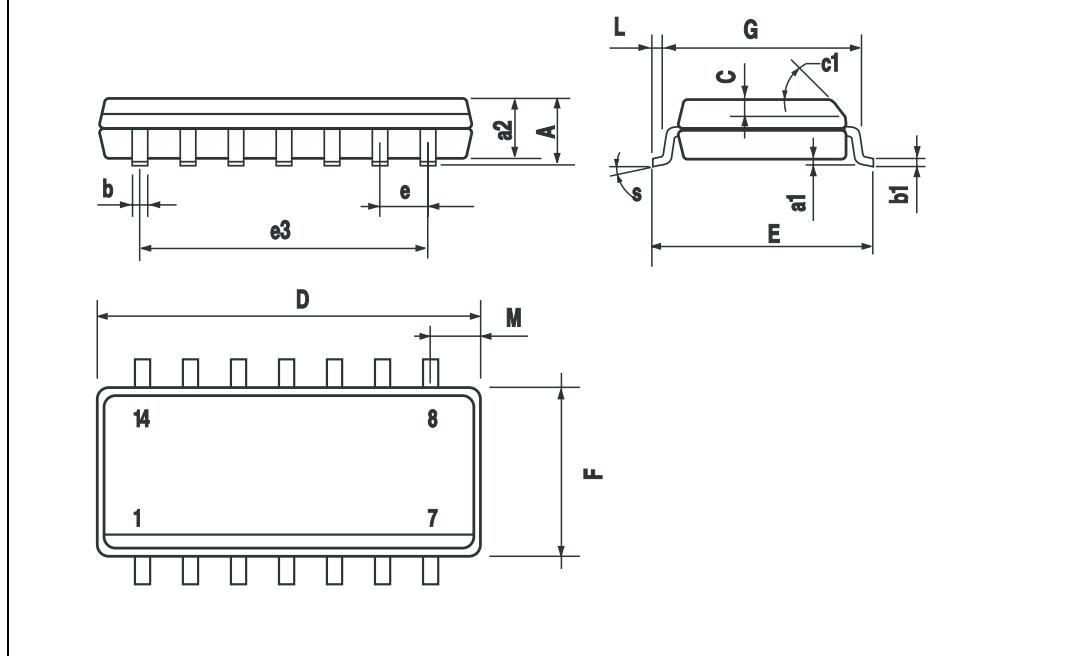
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	
aaa		0.1			0.004	

The figure contains three technical drawings of the TSSOP8 package:

- Top View:** Shows the package outline with pins numbered 1 through 8. Pin 1 is identified by a circle at the bottom left. Dimensions shown are D, E, E1, L, L1, and e.
- Side Cross-Section:** Shows the package thickness (A) and lead height (A1). Other dimensions include b, c, and k. A callout indicates a gage plane at 0.25 mm (0.010 inch).
- Pin 1 Identification:** A separate diagram showing the package from above with a callout pointing to Pin 1.

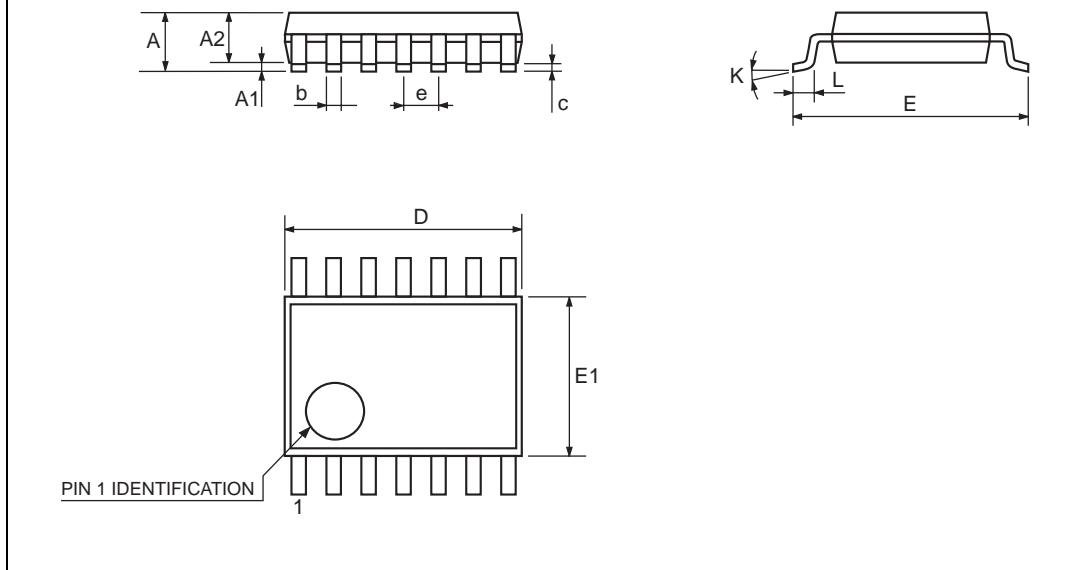
3.3 SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					



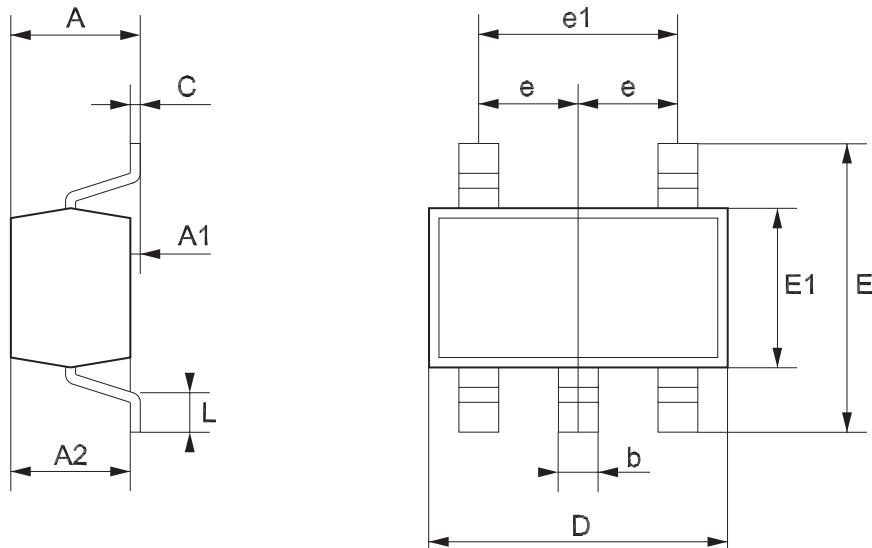
3.4 TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



3.5 SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



4 Ordering information

Table 5. Order codes

Part number	Temperature range	Package	Packaging	Marking
LMV321ILT	-40°C, +125 °C	SOT23-5	Tape & reel	K177
LMV321IYLT ⁽¹⁾		SOT23-5 (Automotive grade)	Tape & reel	K180
LMV321RILT		SOT23-5	Tape & reel	K176
LMV321RIYLT ⁽¹⁾		SOT23-5 (Automotive grade)	Tape & reel	K185
LMV358ID/IDT		SO-8	Tube or tape & reel	LMV358
LMV358IYD/IYDT ⁽¹⁾		SO-8 (Automotive grade)	Tube or tape & reel	LMV358IY
LMV358IPT		TSSOP8	Tape & reel	MV358
LMV358IYPT ⁽¹⁾		TSSOP8 (Automotive grade)	Tape & reel	K181Y
LMV324ID/IDT		SO-14	Tube or tape & reel	LMV324
LMV324IYD/IYDT ⁽¹⁾		SO-14 (Automotive grade)	Tube or tape & reel	V324Y
LMV324IPT		TSSOP14	Tape & reel	MV324
LMV324IYPT		TSSOP14 (Automotive grade)	Tape & reel	V324IY

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent

5 Revision history

Date	Revision	Changes
1-Dec-2005	1	First release - Products in full production.
25-May-2007	2	Added automotive grade part numbers to order codes table. Moved order codes table to Section 4 on page 14 .

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